## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: HIROYAMA, Ryouji et al.

Group Art Unit: 2815

Serial No.: 09/669,448

Examiner: Matthew C. Landau

Filed: September 25, 2000

P.T.O. Confirmation No.: 2968

For:

SEMICONDUCTOR LASER DEVICE AND METHOD OF MANUFACTURING THE

**SAME** 

PETITION TO REQUEST WITHDRAWAL OF PATENT APPLICATION FROM ISSUE UNDER 37 CFR \$1.313(b) RECEIVED

## **MAIL STOP PETITIONS**

NOV 1 6 2004

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

OFFICE OF PETITIONS

November 16, 2004

Sir:

Applicants hereby petition to have the above-captioned patent application withdrawn from issue under 37 CFR §1.313(b)(5).

Although the Issue Fee was paid on April 16, 2004, Applicants are entitled to withdrawal from issue because the application must go abandoned to permit the consideration of an Information Disclosure Statement under 37 CFR §1.97 in a continuing application. Such an Information Disclosure Statement and a CPA are attached hereto. A check for the petition fee of \$130.00 under 37 CFR §1.17(i) is also attached hereto.

## CERTIFICATE OF TRANSMISSION

I hereby certify that this correspondence is being facsimile transmitted to the Patent and Trademark Office:

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U.S. Patent Application Serial No. 09/669,448 PETITION TO REQUEST WITHDRAWAL OF PATENT APPLICATION FROM ISSUE UNDER 37 CFR §1.313(b)(5)

In the event that this paper is not timely filed, applicants respectfully petition for an appropriate extension of time. The fees for such an extension or any other fees which may be due with respect to this paper, may be charged to Deposit Account No. 01-2340.

Respectfully submitted,

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GNS/mla Atty. Docket No. 001241 Suite 1000 1725 K Street, N.W. Washington, D.C. 20006 (202) 659-2930

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Enclosures:

RCE

Information Disclosure Statement